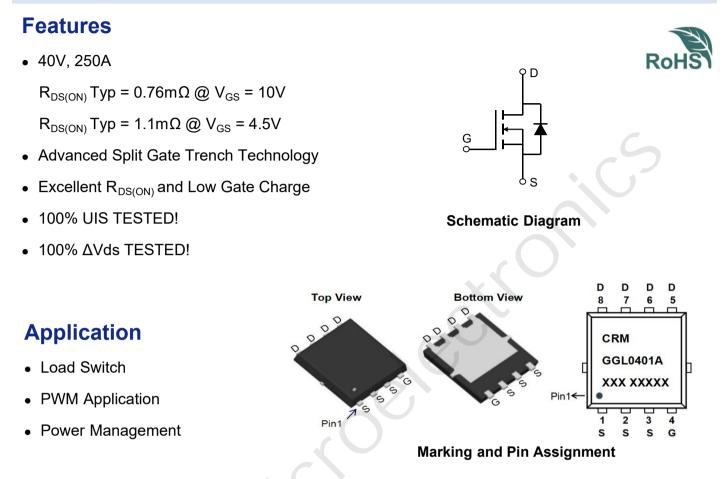


CRMGGL0401A

N-Channel 40V, 0.76mΩ Typ. Power MOSFET

Description



Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGL0401A	CRMGGL0401A	PDFN5x6-8L	TAPING	13"	5000	60000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		40	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	$T_c = 25^{\circ}C$	250	А
I _D		$T_{\rm C}$ = 100°C	160	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		1000	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		576	mJ
P _D	Power Dissipation	$T_c = 25^{\circ}C$	114	W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.1	°C/W
T _J , T _{stg}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	40	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 40V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	1.5	2	V
Р		V_{GS} = 10V, I_{D} = 30A	-	0.76	1	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 4.5V, I _D = 20A	-	1.1	1.45	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	5509	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 20V, f = 1MHz	Χ-	1913	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 110112		148	-	pF
Q _g	Total Gate Charge	0	9.	103	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 32V$, $I_{D} = 20A$	-	51	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 32 v, v_{\rm D} = 20 A$	-	11	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	18	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 20V	-	100	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 3 Ω	-	204	-	ns
t _f	Turn-Off Fall Time		-	73	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _s	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	250	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	1000	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	34	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 30A, di/dt = 100A/us	-	45	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

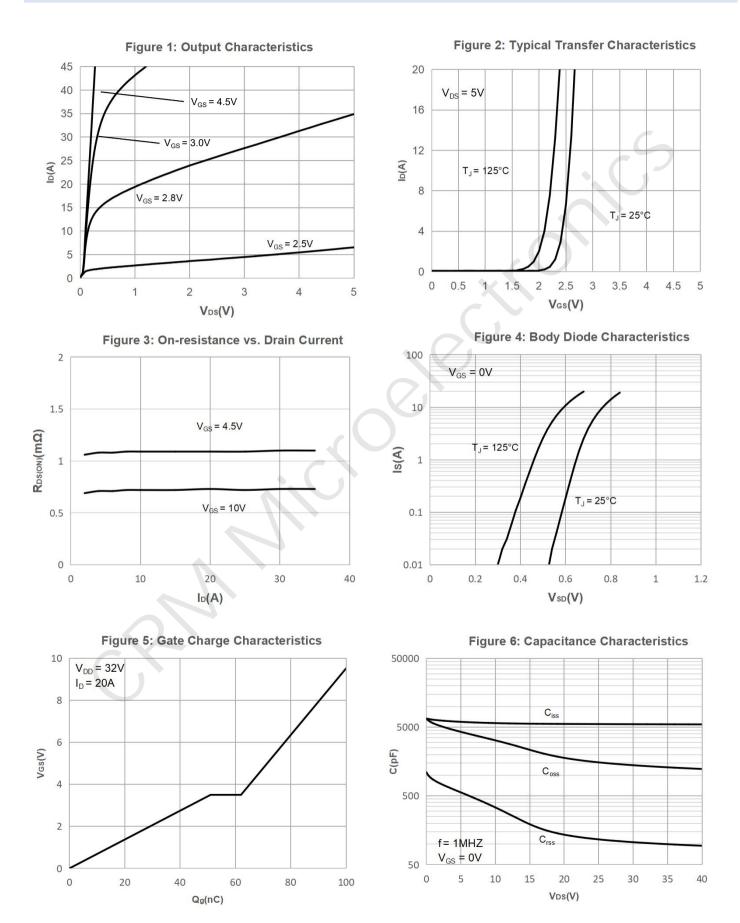
2. E_{AS} condition: Starting T_J=25°C, V_{DD}=20V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=48A

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.



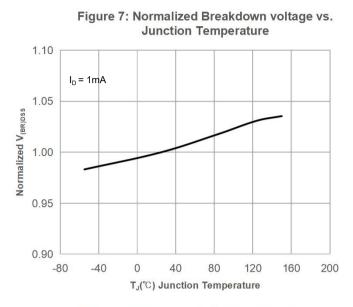
CRMGGL0401A N-Channel 40V, 0.76mΩ Typ. Power MOSFET

Typical Performance Characteristics

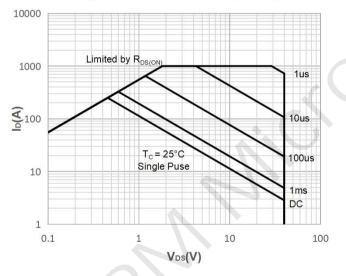


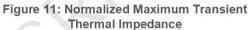


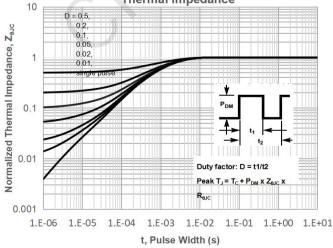
Typical Performance Characteristics











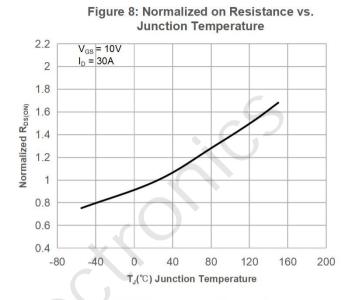


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

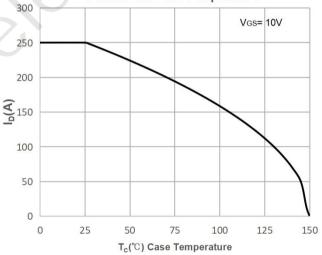
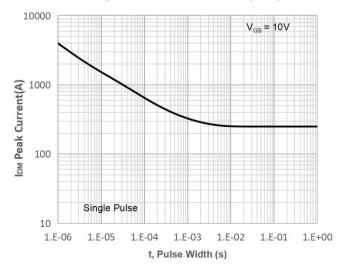


Figure 12: Peak Current Capacity





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Test Circuit

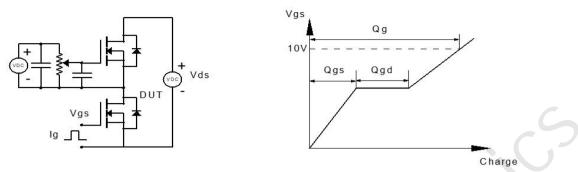


Figure 1: Gate Charge Test Circuit & Waveform

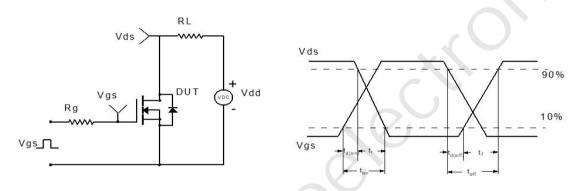
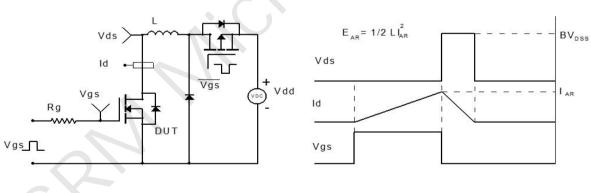


Figure 2: Resistive Switching Test Circuit & Waveform





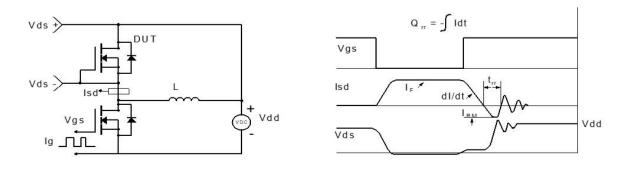


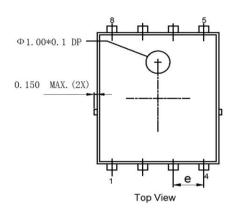
Figure 4: Diode Recovery Test Circuit & Waveform



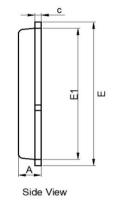
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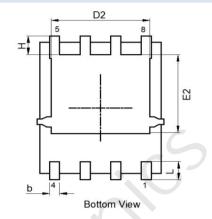
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Package Mechanical Data(PDFN5x6-8L)



Front View





DIM.	MILLIMETER			
DIM.	MIN.	NOM.	MAX.	
A	0.90	1.00	1.10	
b	0.31	0.41	0.51	
с	0.21	0.25	0.34	
D	5.05	5.20	5.40	
D1	4.95	5.05	5.15	
D2	4.00	4.10	4.20	
E	6.30	6.40	6.50	
E1	5.75	5.85	5.95	
E2	3.43	3.53	3.63	
е	1.27BSC			
Н	0.73	0.83	0.93	
L	0.61	0.71	0.81	
θ	0°		12°	

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